

The CDC in its efforts to help students prepare better for the placement process would like to hear your views on different relevant aspects. Would you be willing to spare 2 minutes of your time to fill this form.

This survey is completely optional. That being said, the results of the survey will have an impact on how CDC helps students prepare in future years. If you do choose to fill it, we would urge you to be honest in your answers, after reading, weighing and analysing all options. We promise it won't take more than 2 minutes of your time. Your identity will not be revealed publicly.

☐ Yes

☐ No

Company : Qualcomm India Pvt Ltd

Job Profile

Form Type	Stipend per month	Additional Criteria	CGPA Cut-off
INTERNSHIP	45000 INR [accommodation for entire internship duration and TO and FRO Fligh]		0.0

Job Description

Job Area :Engineering- Hardware Job Location : Bangalore / Hyderabad /Chennai / Noida We know our employees' ideas change the world. For more than three decades, we've been a global leader in mobile technology, continually pushing the boundaries of what's possible. Working with customers across industries — from automotive to health care, from smart cities to robotics— we continue to accelerate innovation and unlock new possibilities in a time where everything is connected. By joining the Qualcomm family, you too can bring the future forward faster. Qualcomm is looking for an energetic, creative and self-driven engineer to work in Modem , Multimedia , Connectivity , Computer Vision and Image Processing , software implementation and hardware acceleration. The work will directly influence the various subsystems within the SoC. The ideal candidate would have very strong problem solving and analytical skills combined with creativity and a passion for innovation. They would be able to carry forward that new idea, concept, and/or application that will propel systems to new levels of effectiveness and efficiency. At Qualcomm you will perform detailed technical analysis, translate ideas into models, SW and/or HW and work closely with other teams to help deliver real products. At Qualcomm, the sky's the limit. College Graduates play important roles everywhere in the company. Many of our 27,000+ employees join us right out of school because we're working on the cutting edge in wireless. Complex wireless devices are only as powerful as the software that runs them. As a software engineer, you will develop, implement and maintain multimedia, gaming and application software for the world's leading-edge mobile devices. We know our employees' ideas change the world. For more than three decades, we've been a global leader in mobile technology, continually pushing the boundaries of what's possible. Working with customers across industries — from automotive to health care, from smart cities to robotics— we continue to accelerate innovation and unlock new possibilities in a time where everything is connected. By joining the Qualcomm family, you too can bring the future forward faster. • SOC & Hard Macro Physical Design • SOC Validation & Debug • RF & Analog Layout • RF/Analog/Mixed Signal/Power IC Design • Low Power Design • Board and FPGA Design\ • Digital ASIC Design • Design/SOC Verification • CAD Solution Engineer • Design for Test (DFT) • CPU Desig Must have educational background in one or more of the following areas: • Verifying SoC with embedded RISC/DSP processors, communications/ networking ASICs. • Verilog or VHDL, C/C++, Tcl/Perl/shell-scripting. RTL design experience and/or strong OO programming knowledge • Knowledge of wireless/wired communications and protocols or graphics/video multimedia is a plus. • Knowledge in PLL, LNA, OpAmp, CMOS, ADC/DAC, Cadence, SpectreRF, or Layout is required in RF/Analog/Mixed Signal IC Design. • Excellent analytical and problem solving skills. • Ability to collaborate and work in teams. • Good verbal and written communication skill Educational Background: Masters, Bachelors: Electrical Engineering , VLSI , Embedded and VLSI , ECE

Selection Process

Resume,Online/Offline test (Max 30 mins)

Allowed Departments and degrees

COMPUTER SCIENCE AND ENGINEERING

B.TECH --- COMPUTER SCIENCE & ENGG. (B.TECH 4Y)

DUAL DEGREE --- COMPUTER SCIENCE & ENGG. (M.TECH DUAL 5Y)

ELECTRICAL ENGINEERING

B.TECH --- ELECTRICAL ENGG. (B.TECH 4Y)

B.TECH --- INSTRUMENTATION ENGG. (B.TECH 4Y)

DUAL DEGREE --- ELECT.ENGG. CONTROL SYSTEM ENGG.(M.TECH DUAL 5Y)

DUAL DEGREE --- ELECT.ENGG. DUAL DEGREE IN ANY SPL.(M.TECH DUAL 5Y)

DUAL DEGREE --- ELECT.ENGG. INSTRUMENTATION AND SIGNAL PROCESSING ENGG.(M.TECH DUAL 5Y)

DUAL DEGREE --- ELECT.ENGG. MACH. DRIVES & POWER ELECT.(M.TECH DUAL 5Y)

DUAL DEGREE --- INSTRUMENTATION AND SIGNAL PROCESSING ENGINEERING(M.TECH DUAL 5Y)

DUAL DEGREE --- INSTRUMENTATION ENGINEERING/CONTROL SYSTEM ENGINEERING(M.TECH DUAL 5Y)

ELECTRONICS AND ELECTRICAL COMMUNICATION ENGG.

B.TECH --- ELECTRONICS & ELEC. COMM.ENGG. (B.TECH 4Y)

DUAL DEGREE --- ELECT.&ELEC.COM.ENGG.DUAL DEGREE IN ANY SPL.(M.TECH DUAL5Y)

DUAL DEGREE --- ELECT.&ELEC.COM.ENGG.MICROELECTRONICS & VLSI DES.(M.TECH DUAL5Y)

DUAL DEGREE --- ELECT.&ELEC.COM.ENGG.TELECOMM SYSTEM ENGG.(M.TECH DUAL5Y)

DUAL DEGREE --- ELECT.&ELEC.COM.ENGG.VISUAL INFORMN. & EMBEDDED SYS.(M.TECH DUAL5Y)

INDUSTRIAL AND SYSTEMS ENGINEERING

B.TECH --- INDUSTRIAL ENGG. (B.TECH 4Y)

DUAL DEGREE --- INDU. ENGG. INDU. ENGG. & MANG. (M.TECH DUAL 5Y)

DUAL DEGREE --- INDUSTRIAL ENGINEERING/FINANCIAL ENGINEERING

DUAL DEGREE --- QUALITY ENGINEERING DESIGN AND MANUFACTURING (INDUSTRIAL ELECTRONICS VERTICAL) (M.TECH DUAL 5Y)

DUAL DEGREE --- QUALITY ENGINEERING DESIGN AND MANUFACTURING (MECHANICAL ENGINEERING VERTICAL)(M.TECH DUAL 5Y)

MATHEMATICS

M.SC(5YR) --- MATHEMATICS & COMPUTING (M.SC. 5Y)